



# CERTIFICATE OF ACCREDITATION

**The ANSI National Accreditation Board**

Hereby attests that

**Premier Semiconductor Services LLC  
dba Micross**

**4400 140<sup>th</sup> Ave. N., Suite 140  
Clearwater, FL 33762**

Fulfills the requirements of

**ISO/IEC 17025:2017**

and the

**AS6171 Detection of Suspect/Counterfeit Parts  
Accreditation Program**

In the field of

**TESTING**

This certificate is valid only when accompanied by a current scope of accreditation document.  
The current scope of accreditation can be verified at [www.anab.org](http://www.anab.org).

Jason Stine, Vice President

Expiry Date: 06 September 2024

Certificate Number: AT-3126



This laboratory is accredited in accordance with the recognized International Standard ISO/IEC 17025:2017.  
This accreditation demonstrates technical competence for a defined scope and the operation of a laboratory  
quality management system (refer to joint ISO-ILAC-IAF Communiqué dated April 2017).



**SCOPE OF ACCREDITATION TO ISO/IEC 17025:2017**

**Premier Semiconductor Services LLC  
dba Micross**

4400 140<sup>th</sup> Ave. N., Suite 140  
Clearwater, FL 33762

Gabriela Manugas  
Gabriela.manugas@micross.com

**TESTING**

In recognition of a successful assessment to ISO/IEC 17025:2017 General Requirements for the competence of Testing and Calibration Laboratories, AS6171 General Requirements, and the requirements of the ANAB SR 2429 – Labs Performing Detection of Suspect/Counterfeit Parts Under AS6171 program, accreditation is granted to **Premier Semiconductor Services LLC dba Micross** to perform the following AS6171 slash sheet tests:

Valid to: September 6, 2024

Certificate Number: **AT-3126**

**Mechanical (Inspection and NDT)**

Specific Tests and/or Properties Measured	Specification, Standard, Method, or Test Technique	Items, Materials or Product Tested	Key Equipment or Technology
Visual Inspection	AS6081 AS6171 AS6171/2 IDEA-STD-1010 Internal Procedure: CLW-WI-0086 MIL-STD-750-2 Test Method: 2068, 2071 MIL-STD-883-2 Test Method: 2009	Electrical, Electronic and Electromechanical (EEE) Components	Multiple Digital Microscopes and Digital Camera

**Mechanical (Inspection and NDT)**

Specific Tests and/or Properties Measured	Specification, Standard, Method, or Test Technique	Items, Materials or Product Tested	Key Equipment or Technology
Package Configuration Physical Dimensions	AS6081 AS6171 AS6171/2 IDEA-STD-1010 Internal Procedure: CLW-WI-0086 MIL-STD-750-2 Test Method: 2066 MIL-STD-883-2 Test Method: 2016	Electrical, Electronic and Electromechanical (EEE) Components	Non-contact measurement tool and Calipers
Resistance to Solvents (Remarking & Resurfacing) Scrape Test	AS6081 AS6171 AS6171/2 IDEA-STD-1010 Internal Procedure: CLW-WI-0066 MIL-STD-202-215 MIL-STD-750-2 Test Method: 1022 MIL-STD-883-2 Test Method: 2015	Electrical, Electronic and Electromechanical (EEE) Components	Multiple Microscopes, Hot Plate, X-Acto Knife, and Solvents
Black Top Detection	AS6081 AS6171 AS6171/2 IDEA-STD-1010 Internal Procedure: CLW-WI-0066	Electrical, Electronic and Electromechanical (EEE) Components	Multiple Microscopes, Hot Plate, X-Acto Knife, Dynasolve, and 1-Methyl 2- Pyrrolidinone (1-M-2)
Radiographic Examination / Inspection	AS6081 AS6171 AS6171/5 IDEA-STD-1010 Internal Procedure: CLW-WI-0067 MIL-STD-202-209 MIL-STD-750-2 Test Method: 2076 MIL-STD-883-2 Test Method: 2012	Electrical, Electronic and Electromechanical (EEE) Components	X-Ray Machine, IQI set

**Mechanical (Inspection and NDT)**

Specific Tests and/or Properties Measured	Specification, Standard, Method, or Test Technique	Items, Materials or Product Tested	Key Equipment or Technology
Decapsulation and Die Verification	AS6081 AS6171 AS6171/4 IDEA-STD-1010-B Internal Procedure: CLW-WI-0083 MIL-STD-750-2 Test Method: 2072, 2075, 2101, 2102 MIL-STD-883-2 Test Method: 2013	Electrical, Electronic and Electromechanical (EEE) Components	Acid Decapsulator, Kiln, Hot Plates
Solderability	Internal Procedure: CLW-WI-0067 IDEA-STD-1010-B J-STD-002 MIL-STD-202-208 MIL-STD-750-2 Test Method: 2026 MIL-STD-883-2 Test Method: 2003	Electrical, Electronic and Electromechanical (EEE) Components	Steam Ager, Multiple Microscopes, and Solder Pot
X-Ray Fluorescence (XRF) ROHS/Thickness	AS6081 AS6171 AS6171/3 IDEA-STD-1010 Internal Procedure: CLW-WI-0011 MIL-STD-750-2 Test Method: 2100 MIL-STD-883-2 Test Method: 2037	Electrical, Electronic and Electromechanical (EEE) Components	X-Ray Fluorescence (XRF) machine
Thermal Cycle Test (Temperature Test)	AS6081 AS6171 AS6171/7 IDEA-STD-1010 Internal Procedure: CLW-OP-0078	Electrical, Electronic and Electromechanical (EEE) Components	Temperature Forcing System, Bench Equipment and Automated Test Equipment (ATE)

**Electrical**


Specific Tests and/or Properties Measured	Specification, Standard, Method, or Test Technique	Items, Materials or Product Tested	Key Equipment or Technology
Programming/Flash/Memory	Internal Procedure: CLW-WI-0051	Electrical, Electronic and Electromechanical (EEE) Components	Programmer

**Electrical**

Specific Tests and/or Properties Measured	Specification, Standard, Method, or Test Technique	Items, Materials or Product Tested	Key Equipment or Technology
DDR/SRAM	Internal Procedure: CLW-WI-0051	Electrical, Electronic and Electromechanical (EEE) Components	RAM Tester
Electrical Test Electrical, Electronic and Electromechanical (EEE) Components	AS6081 AS6171 AS6171/7 IDEA-STD-1010 Internal Procedure: CLW-OP-0078	Electrical, Electronic and Electromechanical (EEE) Components	Bench Equipment and Automated Test Equipment (ATE)
Electrical Test (Digital) Microcircuits	MIL-STD-883-3 Class 3000	Electrical, Electronic and Electromechanical (EEE) Components	Bench Equipment and Automated Test Equipment (ATE)
Electrical Test (Linear) Microcircuits	MIL-STD-883-4 Class 4000	Electrical, Electronic and Electromechanical (EEE) Components	Bench Equipment and Automated Test Equipment (ATE)
Transistor Electrical Test Semiconductor Devices	MIL-STD-750-3 Class 3000	Electrical, Electronic and Electromechanical (EEE) Components	Bench Equipment and Automated Test Equipment (ATE)
Diode Electrical test Semiconductor Devices	MIL-STD-750-4 Class 4000	Electrical, Electronic and Electromechanical (EEE) Components	Bench Equipment and Automated Test Equipment (ATE)

Note:

1. This scope is formatted as part of a single document including Certificate of Accreditation No. AT-3126.



Jason Stine, Vice President